

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s)

Kutaragi et al.

Serial No.

09/764,475

For

,

METHOD AND SYSTEM FOR PROCESSING BUSINESS

Filed

January 17, 2001

Art Unit

2161

745 Fifth Avenue New York, NY 10151

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, DC 20231, on.

William S. Frommer, Reg. No. 25,506

Name of Applicant, Assignee or Registered Representative

May 31, 2002

Date of Signature

REVOCATION AND NEW POWER OF ATTORNEY AND STATEMENT UNDER 3.73(b)

Asst. Commissioner for Patents Washington, D.C. 20231

Sir:

Under 37 C.F.R. §3.73(b) Sony Computer Entertainment, Inc., a Japanese corporation with offices at 1-1 Akasaka 7-cho-me, Minato-ku, Tokyo, 107-0052 Japan, certifies that it is the assignee of 100% of the right, title and interest in the patent application identified above by virtue of an assignment from the inventors of the patent application identified above. The

assignment is being filed concurrently with this Revocation and New Power of Attorney. A copy of the assignment is enclosed.

The undersigned has reviewed all the documents in the chain of title of the patent application identified above and, to the best of undersigned's knowledge and belief, title is in the assignee identified above.

The undersigned, whose title is supplied below, is empowered to act on behalf of the assignee.

The undersigned, acting on behalf of the assignee, hereby revokes all powers of attorney previously granted in the application and appoints:

William S. Frommer (Reg. Number 25,506), and Hans R. Mahr (Reg. Number 46,138)
Frommer Lawrence & Haug LLP
745 Fifth Avenue
New York, NY 10151

With full power of substitution and revocation, to prosecute the application and to transact all business in the United States Patent and Trademark Office connected therewith.

All correspondence regarding the application should be sent to William S. Frommer at Frommer Lawrence & Haug LLP, 745 Fifth Avenue, New York, NY 10151; telephone (212)588-0800; facsimile (212)588-0500.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United Statement Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Sony Computer Entertainment, Inc.

Date: April 30, 2002

Tetsuje Kohayaoli Tetsuya Kobayashi

Vice-President

SCEI Ref.: SC00121US00 TMK Ref.: SC161401

Docket No.: 444.12.01

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in:

METHOD AND SYSTEM FOR PROCESSING BUSINESS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address:

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-1, Akasaka 7-chome, Minato-ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the application number and filing date of this application in the spaces that follow: Application Number: 09/764,475, Filing Date: January 17, 2001.

Toru KUWAHARA

Name of First or Sole Inventor

Residence of First or Sole Inventor

Toru Kuwahara

Residence of First or Sole Inventor

Toru Kuwahara

Signature of First or Sole Inventor

Date of this Assignment

Akira SAITO	May/01/200/
Name of Second Inventor	Execution Date of U.S. Patent Application
Saitama. Japan	
Saitama. Japan Residence of Second Inventor	May /01/200/ Date of this Assignment
Signature of Second Inventor	Date of this Assignment
Tanjo WAKIMOTO	Execution Date of U.S. Patent Application
Name of Third Inventor	Execution Date of U.S. Patent Application
Chība, Japan Residence of Third Inventor	
Tujo Wakiron Signature of Third Inventor	May 25, 200 / Date of this Assignment
Signature of Third Inventor	Date of this Assignment
Kazuya TAMURA	May 25, 200 / Execution Date of U.S. Patent Application
Name of Fourth Inventor	Execution Date of U.S. Patent Application
Tokyo, Japan Residence of Fourth Inventor	
Kazuya Tamura Signature of Fourth Inventor	May 25, 200/ Date of this Assignment
Signature of Fourth Inventor	Date of this Assignment
Hajime HIRANO	May 5. 200/ Execution Date of U.S. Patent Application
Name of Fifth Inventor	Execution Date of U.S. Patent Application
A Saka Japaw . Residence of Fifth Inventor	
Signature of Fifth Inventor	
Signature of Fifth Inventor	Date of this Assignment
Vor WIMADAGI	No. of the same of
Ken KUTARAGI Name of Sixth Inventor	Execution Date of U.S. Patent Application
Residence of Fourth Inventor	
たろえる 付	22. MAY. 200/
Signature of Sixth Inventor	Date of this Assignment